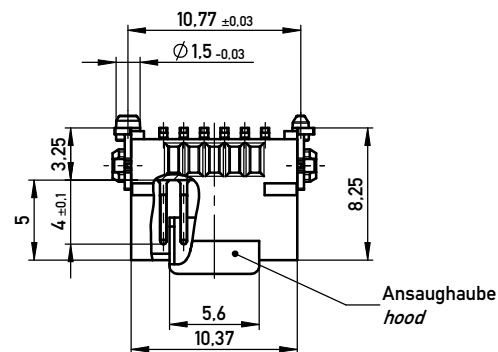
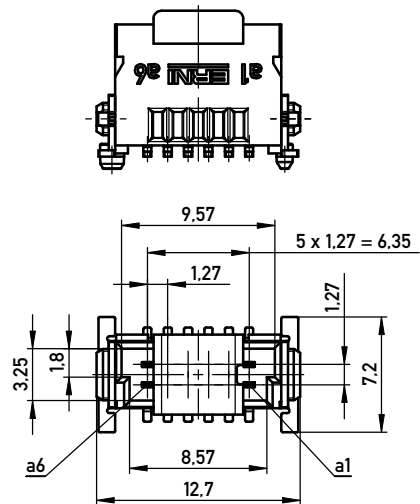


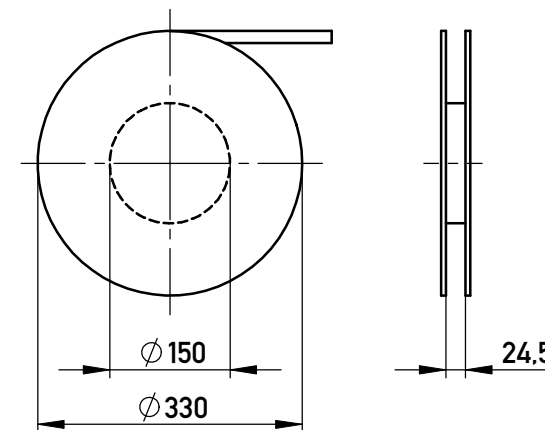
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

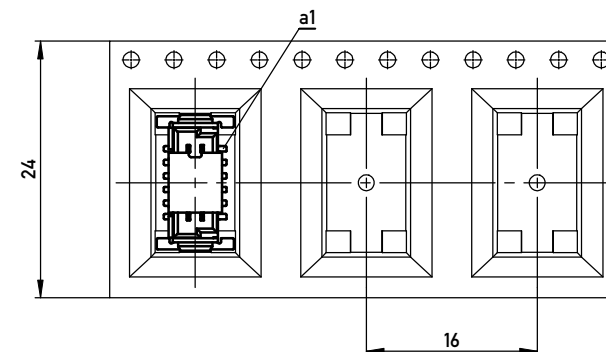
Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0.1 mm
Coplanarity Area of Termination ≤ 0.1 mm

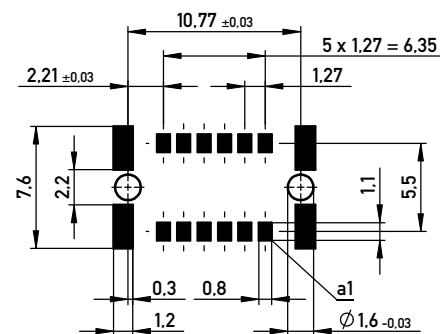
Verpackt in Gurtverpackung - Tape on Reel Packaging
Verpackungseinheit: 280 Stück - Packaging unit: 280 pcs



Abspulrichtung - Reel off Direction



Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



BA 8-03 - Standard Bauhöhe
type 8-03 - Standard Assembly Height

Information:		Tolerances		Scale	3:1
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b		27.10.2010		Messerl. SMC-Q-12-SMD-BA8-03	
Index		Date		Male SMC-Q 12-SMD-type8-03	
		ERNI www.ERNI.com		244854	
				I	
				A3	
				Class	
				SMCQ	

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